

Examiner : A. Chambliss

Art Unit : 2827

Docket No.: 52433/544

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : K. TATSUMI et al.

Serial No. : 09/254,118

Filed : May 19, 1999

For : METHOD OF PARTIALLY PLATING SUBSTRATE FOR

ELECTRONIC DEVICES

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

TRANSMITTAL LETTER

SIR:

Transmitted herewith is an Amendment/Response in the above-identified patent application.

[X] No additional fee is required.

The fee has been calculated as shown below.

				SMALL ENTITY							OTHER THAN A SMALL ENTITY		
CL	AIMS	Н	IGHE	ST N	o.	1	RATE		ADDIT	. <u>OR</u>	RATE		ADDIT.
REMAINING PREVIO			OUSLY PRESENT				FEE				FEE		FEE
AFTER PA				FOR	EXT	AS							
<u>AM</u>	ENDMEN	T											
TOTAL	10	MINUS	20	=	0		x 6=	\$			x18 =	\$	0.00
INDEP.	1	MINUS	3	=	0		x 18=	\$			×86 =	\$	0.00
[]FIRST PRESENTATION OF MULTIPLE				TIPLE		x60=	\$_			x290=	\$_	0.00	
DEP. CLAIM TOTAL													
					ADDI	T. 1	FEE	\$_		OR		\$_	0.00

[X] The Commissioner is hereby authorized to charge fees under 37 CFR 1.16 and 1.17 which may be required to Deposit Account 11-0600. A duplicate of this paper is enclosed.

A petition for a two (2) month extension of time and Deposit Account authorization to cover the extension fee are enclosed.

[] Terminal Disclaimer and Deposit Account Authorization.

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on November 4, 2004

John J. Kelly J.

John J. Kelly, Jr. Red. No. 29,182

Respectfully submitted,

KENYON & KENYON

By: John J. Kelly, Jr.

Reg. No. 29,182

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